

Singulation System

Model FMS3040-FC



Singulation system for cutting substrates

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- Fully automatic from cutting to washing/drying and visual inspection.
- Supports cutting of flip chip substrates.
- Ocompatible with substrates up to Max. W242 \times L322.5 \times t2.5 mm in size.
- Achieving high-precision cutting with optimal jig dicers and handlers that meet customer needs.
- Visual inspection function equipped as standard. Supports substrate thickness autofocus.





SPECIFICATION

Items		Unit	Description	
Model		_	FMS3040-FC	
Machine type		_	Tray type	
Workpiece size	Length	mm	267.2—322.5	
	Width	mm	150—242	
	Thickness	mm	0.6—2.5	
Package size	Min.	mm	12×12	
	Max.	mm	60×60	
Warpage amount of substrate		_	2mm/200mm (Max.)	
Saw engines		_	Twin spindles, Twin tables	
External dimensions	Module	module	Cut Engine	Offload
	Width	mm	2,255	1,625
	Depth	mm	1,760	1,760
	Height	mm	2,200	1,800
Weight		ton	5.4	
Onload	Туре	_	Slit magazine	
	Pieces	pcs	2 (Max.) In case substrate width is 320mm	
Offload	Туре	_	JEDEC Tray	
	Pieces	pcs	50 (Max.)	
Number of pick and place head		_	2units×7pcs (Option: 2units×11pcs)	
Conversion time		min	15	
Package handling method		_	Vacuum	
Machine capacity		UPH	730	

- · The figures shown above are based on standard machine specifications.
- The above specification are subject to change without prior notice.
- · For special requirements, please consult your local TOWA representative.

TOWA CORPORATION

Headquarters

5 Kamichoshi-cho, Kamitoba, Minami-ku, Kyoto-shi, Kyoto 601-8105 Japan

Contact Us



Overseas Sales Contacts

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TOWA (Shanghai) Co., Ltd.

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